19-1260; Rev 1; 9/02

MAXIM

+3V/+5V, 12-Bit, Serial, Multiplying DACs in 10-Pin µMAX Package

General Description

The MAX551/MAX552 are 12-bit, current-output, 4-quadrant multiplying digital-to-analog converters (DACs). These devices are capable of providing unipolar or bipolar outputs when operating from either a single +5V (MAX551) or +3V (MAX552) power supply. An internal power-on-reset circuit clears all DAC registers on power-up, setting the DAC output voltage to 0V.

The SPI™/QSPI™ and MICROWIRE™-compatible 3-wire serial interface saves board space and reduces power dissipation compared with parallel-interface devices. The MAX551/MAX552 feature double-buffered interface logic with a 12-bit input register and a 12-bit DAC register. Data in the DAC register sets the DAC output voltage. Data is loaded into the input register through the serial interface. The $\overline{LOAD}$ input transfers data from the input register to the DAC register, updating the DAC output voltage.

The MAX551/MAX552 are available in an 8-pin DIP package or a space-saving 10-pin µMAX package. The µMAX package provides an asynchronous clear ($\overline{CLR}$) input that clears all DAC registers when pulled to GND, setting the output voltage to 0V.

Applications

Automatic Calibration
Gain Adjustment
Transducer Drivers
Process-Control I/O Boards
Digitally Controlled Filters
Motion-Controlled Systems
µP-Controlled Systems
Programmable Amplifiers/Attenuators

Features

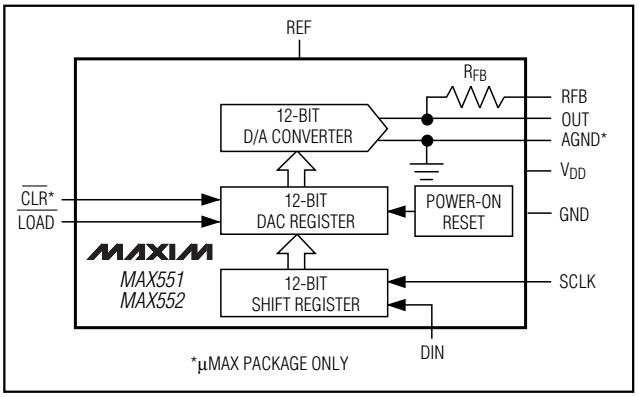
- **Single-Supply Operation:**
  +4.5V to +5.25V (MAX551)
  +2.7V to +3.6V (MAX552)
- **12.5MHz 3-Wire Serial Interface**
- **SPI/QSPI and MICROWIRE Compatible**
- **Power-On Reset Clears DAC Output to Zero**
- **Asynchronous Clear Input Clears DAC Output to Zero**
- **Voltage Mode or Bipolar Mode Operation with a Single Power Supply**
- **Schmitt-Trigger Digital Inputs for Direct Optocoupler Interface**
- **0.4µA Supply Current**
- **10-Pin µMAX Package**

Ordering Information

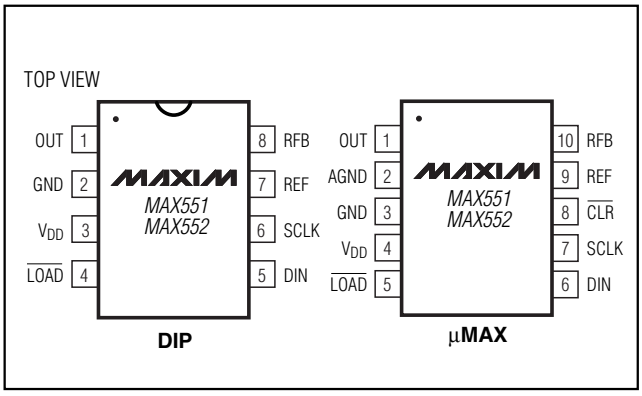
PART	TEMP RANGE	PIN-PACKAGE	LINEARITY (LSB)
MAX551ACPA	0°C to +70°C	8 Plastic DIP	±1/2
MAX551BCPA	0°C to +70°C	8 Plastic DIP	±1
MAX551ACUB	0°C to +70°C	10 µMAX	±1/2
MAX551BCUB	0°C to +70°C	10 µMAX	±1
MAX551AEPA	-40°C to +85°C	8 Plastic DIP	±1/2
MAX551BEPA	-40°C to +85°C	8 Plastic DIP	±1
MAX551AEUB	-40°C to +85°C	10 µMAX	±1/2
MAX551BEUB	-40°C to +85°C	10 µMAX	±1

Ordering Information continued at end of data sheet.

Functional Diagram



Pin Configurations



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For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

+3V/+5V, 12-Bit, Serial, Multiplying DACs in 10-Pin µMAX Package

ABSOLUTE MAXIMUM RATINGS

V_{DD} to GND 6V
REF, RFB to GND .....±12V
Digital Inputs (SCLK, DIN, $\overline{LOAD}$, $\overline{CLR}$)
to GND .....-0.3V to 6V
OUT to GND .....-0.3V to (V_{DD} + 0.3V)
AGND to DGND .....±0.3V
Continuous Power Dissipation (T_A = +70°C)
Plastic DIP (derate 9.09mW/°C above +70°C) 727mW
µMAX (derate 5.60mW/°C above +70°C) 444mW

Operating Temperature Ranges
MAX55_ _C_ _ .....0°C to +70°C
MAX55_ _E_ _ .....-40°C to +85°C
Storage Temperature Range .....-65°C to +150°C
Lead Temperature (soldering, 10s) .....+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—MAX551

(V_{DD} = +4.5V to +5.25V, V_{REF} = 5V, OUT = AGND = GND, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
STATIC PERFORMANCE							
Resolution	N			12			Bits
Integral Nonlinearity	INL		MAX551A			±1/2	LSB
			MAX551B			±1	
Differential Nonlinearity	DNL	Guaranteed monotonic over temperature	MAX551A			±1/2	LSB
			MAX551B			±1	
Gain Error		Using internal feedback resistor (R_{FB})	MAX551A			±1	LSB
			MAX551B			±2	
Gain Tempco (ΔGain/ΔTemp)		Using internal feedback resistor (R_{FB}) (Note 2)			±0.2	±1	ppm/°C
Power-Supply Rejection	PSR	ΔV_{DD} = +5%, -10%				2	ppm/%
DYNAMIC PERFORMANCE (Note 3)							
Current Settling Time	t_S	T_A = +25°C, to 1/2LSB, OUT load is 100Ω‖13pF, DAC register alternately loaded with 1s and 0s			0.08	1	µs
Digital-to-Analog Glitch		V_{REF} = 0V, OUT load is 100Ω‖13pF, DAC register alternately loaded with 1s and 0s			0.65	20	nV-s
AC Feedthrough at OUT		V_{REF} = $5V_{P-P}$ at 10kHz, DAC register loaded with all 0s			0.3	1	mV_{P-P}
Total Harmonic Distortion	THD	V_{REF} = $6V_{RMS}$ at 1kHz, DAC register loaded with all 1s			-85		dB
Output Noise-Voltage Density		10Hz to 100kHz, measured between RFB and OUT			13	15	$nV/\sqrt{Hz}$

ELECTRICAL CHARACTERISTICS—MAX551 (continued)

(V_{DD} = +4.5V to +5.25V, V_{REF} = 5V, OUT = AGND = GND, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
REFERENCE INPUT							
Input Resistance	R_{REF}	Measured between REF and OUT		7	11	15	kΩ
Input Resistance Tempco					6.5		ppm/°C
Reference -3dB Bandwidth	BW	V_{OUT} = 0.31V_{P-P}, R_L = 50Ω, code = full-scale			725		kHz
ANALOG OUTPUT							
OUT Leakage Current		DAC register loaded with all 0s	T_A = +25°C		±0.15	±5	nA
			T_A = T_{MIN} to T_{MAX}			±25	
OUT Capacitance	C_{OUT}	Code = zero scale (Note 2)			14	20	pF
		Code = full scale (Note 2)			20	30	
DIGITAL INPUTS							
Input High Voltage	V_{IH}			2.4			V
Input Low Voltage	V_{IL}					0.8	V
Input Hysteresis	HYST	$\overline{LOAD}$, $\overline{CLR}$, DIN, and SCLK, V_{DD} = 5V			156		mV
Input Leakage Current	I_{IN}	$\overline{CLR}$	$V_{\overline{CLR}}$ = V_{DD}			±1	µA
			$V_{\overline{CLR}}$ = 0V		18	100	
		SCLK, $\overline{LOAD}$, DIN	Inputs at 0V or V_{DD}			±1	
Input Capacitance	C_{IN}	Inputs at 0V or V_{DD} (Note 2)				8	pF
SWITCHING CHARACTERISTICS							
SCLK Pulse Width High	t_{CH}			25			ns
SCLK Pulse Width Low	t_{CL}			25			ns
DIN Data to SCLK Setup	t_{DS}			15			ns
DIN Data to SCLK Hold	t_{DH}			15			ns
$\overline{LOAD}$ Pulse Width	t_{LD}			20			ns
LSB SCLK to $\overline{LOAD}$	t_{SL}			0			ns
$\overline{LOAD}$ High to SCLK	t_{LC}			15			ns
$\overline{CLR}$ Pulse Width	t_{CLR}			20			ns
POWER SUPPLY							
Supply Voltage	V_{DD}			4.50		5.25	V
Supply Current	I_{DD}	All digital inputs at V_{IL} or V_{IH}, $\overline{CLR}$ = V_{DD}			0.5	1.5	mA
		All digital inputs at 0V or V_{DD}, $\overline{CLR}$ = V_{DD}			0.4	5	µA

+3V/+5V, 12-Bit, Serial, Multiplying DACs in 10-Pin µMAX Package

ELECTRICAL CHARACTERISTICS—MAX552

(V_{DD} = +2.7V to +3.6V, V_{REF} = 2.5V, OUT = AGND = GND, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
STATIC PERFORMANCE							
Resolution	N			12			Bits
Integral Nonlinearity	INL		MAX552A			±1/2	LSB
			MAX552B			±1	
Differential Nonlinearity	DNL	Guaranteed monotonic over temperature	MAX552A			±1/2	LSB
			MAX552B			±1	
Gain Error		Using internal feedback resistor (R_{FB})	MAX552A			±1	LSB
			MAX552B			±2	
Gain Tempco (ΔGain/ΔTemp)		Using internal feedback resistor (R_{FB}) (Note 2)			±0.3	±1	ppm/°C
Power-Supply Rejection	PSR	ΔV_{DD} = +20%, -10%				1	ppm/%
DYNAMIC PERFORMANCE (Note 3)							
Current Settling Time	t_S	T_A = +25°C, to 1/2LSB, OUT load is 100Ω‖13pF, DAC register alternately loaded with 1s and 0s			0.12	1	µs
Digital-to-Analog Glitch		V_{REF} = 0V, OUT load is 100Ω‖13pF, DAC register alternately loaded with 1s and 0s			0.6	20	nV-s
AC Feedthrough at OUT		V_{REF} = $3V_{P-P}$ at 10kHz, DAC register loaded with all 0s			0.2	0.6	mV_{P-P}
Total Harmonic Distortion	THD	V_{REF} = $6V_{RMS}$ at 1kHz, DAC register loaded with all 1s			-85		dB
Output Noise-Voltage Density		10Hz to 100kHz, measured between RFB and OUT			13	15	$nV/\sqrt{Hz}$
REFERENCE INPUT							
Input Resistance	R_{REF}	Measured between REF and OUT		7	11	15	kΩ
Input Resistance Tempco					7.5		ppm/°C
Reference -3dB Bandwidth	BW	V_{OUT} = $0.31V_{P-P}$, R_L = 50Ω, code = full-scale			725		kHz
ANALOG OUTPUT							
OUT Leakage Current		DAC register loaded with all 0s	T_A = +25°C		±0.13	±5	nA
			T_A = T_{MIN} to T_{MAX}			±25	
OUT Capacitance	C_{OUT}	Code = zero code (Note 2)			14	20	pF
		Code = full scale (Note 2)			20	30	

ELECTRICAL CHARACTERISTICS—MAX552 (continued)

(V_{DD} = +2.7V to +3.6V, V_{REF} = 2.5V, VOUT = AGND = GND, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DIGITAL INPUTS							
Input High Voltage	V_{IH}			2.1			V
Input Low Voltage	V_{IL}					0.6	V
Input Hysteresis	HYST	$\overline{LOAD}$, $\overline{CLR}$, DIN, and SCLK, V_{DD} = 3V			135		mV
Input Leakage Current	I_{IN}	$\overline{CLR}$	$V_{\overline{CLR}} = V_{DD}$			±1	µA
			$V_{\overline{CLR}}$ = 0V		12	75	
		SCLK, $\overline{LOAD}$, DIN	Inputs at 0V or V_{DD}			±1	
Input Capacitance	C_{IN}	Inputs at 0V or V_{DD} (Note 2)				8	pF
SWITCHING CHARACTERISTICS							
SCLK Pulse Width High	t_{CH}			40			ns
SCLK Pulse Width Low	t_{CL}			40			ns
DIN Data to SCLK Setup	t_{DS}			15			ns
DIN Data to SCLK Hold	t_{DH}			15			ns
$\overline{LOAD}$ Pulse Width	t_{LD}			30			ns
LSB SCLK to $\overline{LOAD}$	t_{SL}			0			ns
$\overline{LOAD}$ High to SCLK	t_{LC}			15			ns
$\overline{CLR}$ Pulse Width	t_{CLR}			30			ns
POWER SUPPLY							
Supply Voltage	V_{DD}			2.7		3.6	V
Supply Current	I_{DD}	All digital inputs at V_{IL} or V_{IH}, $\overline{CLR}$ = V_{DD}			0.1	0.5	mA
		All digital inputs at 0V or V_{DD}, $\overline{CLR}$ = V_{DD}			0.07	5	µA

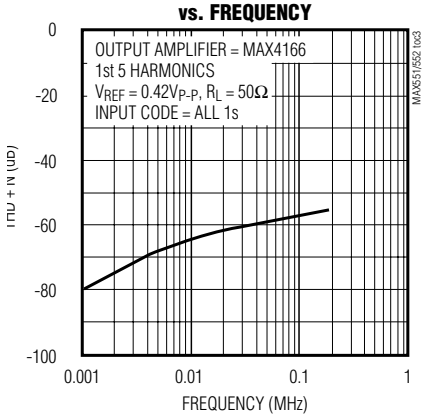
Note 1: AGND and $\overline{CLR}$ are for µMAX only.
Note 2: Guaranteed by design. Not subject to production testing.
Note 3: Parametric limits are provided for design guidance, and are not production tested.

+3V/+5V, 12-Bit, Serial, Multiplying DACs in 10-Pin µMAX Package

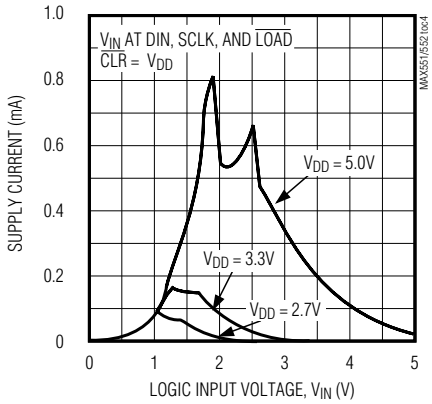
Typical Operating Characteristics

(T_A = +25°C, unless otherwise noted.)

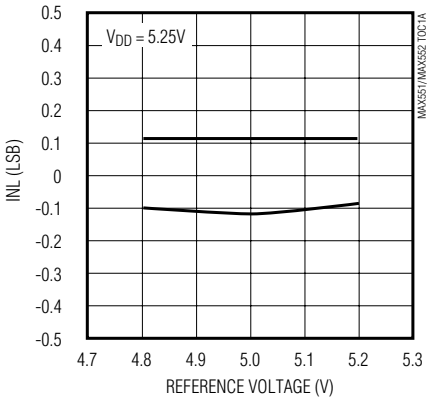
MAX551
TOTAL HARMONIC DISTORTION vs. FREQUENCY



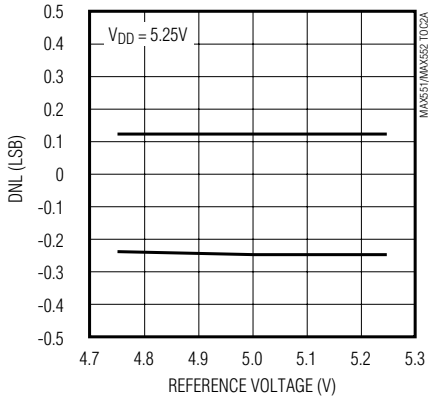
SUPPLY CURRENT vs. LOGIC INPUT VOLTAGE



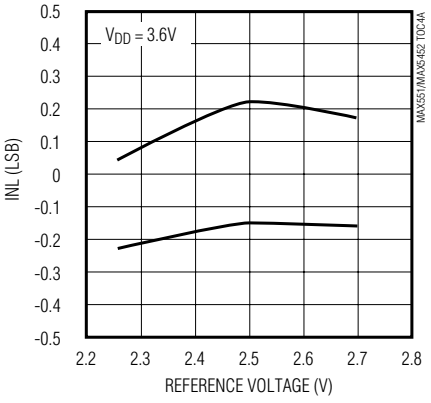
MAX551
INL vs. REFERENCE VOLTAGE



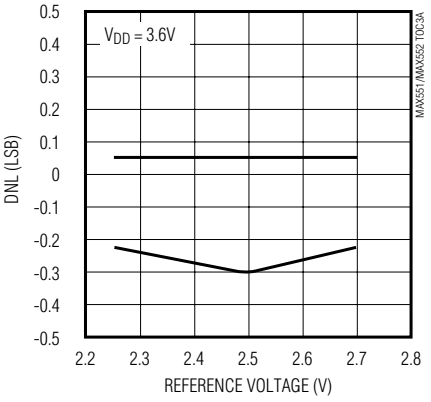
MAX551
DNL vs. REFERENCE VOLTAGE



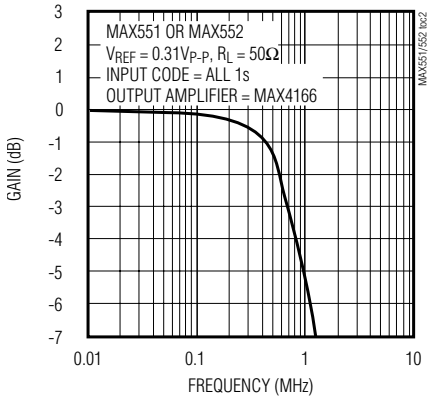
MAX552
INL vs. REFERENCE VOLTAGE



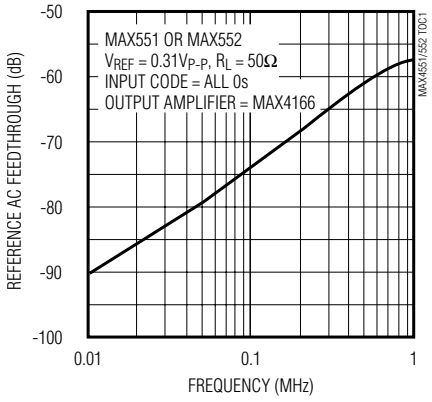
MAX552
DNL vs. REFERENCE VOLTAGE



MULTIPLYING FREQUENCY RESPONSE



REFERENCE AC FEEDTHROUGH vs. FREQUENCY



Pin Description

PIN		NAME	FUNCTION
DIP	µMAX		
1	1	OUT	DAC Current Output
—	2	AGND	Analog Ground
2	3	GND	Digital Ground. Also Analog Ground for DIP package.
3	4	V_{DD}	Supply Voltage
4	5	$\overline{LOAD}$	Active-Low Load DAC Input. Driving this asynchronous input low transfers the contents of the input register to the DAC register.
5	6	DIN	Serial-Data Input
6	7	SCLK	Serial-Clock Input. The serial input data is clocked in on SCLK's rising edge.
—	8	$\overline{CLR}$	Clear DAC Input. Clears the DAC register. Tie to V_{DD} or float if not used.
7	9	REF	Reference Input
8	10	RFB	Feedback Resistor

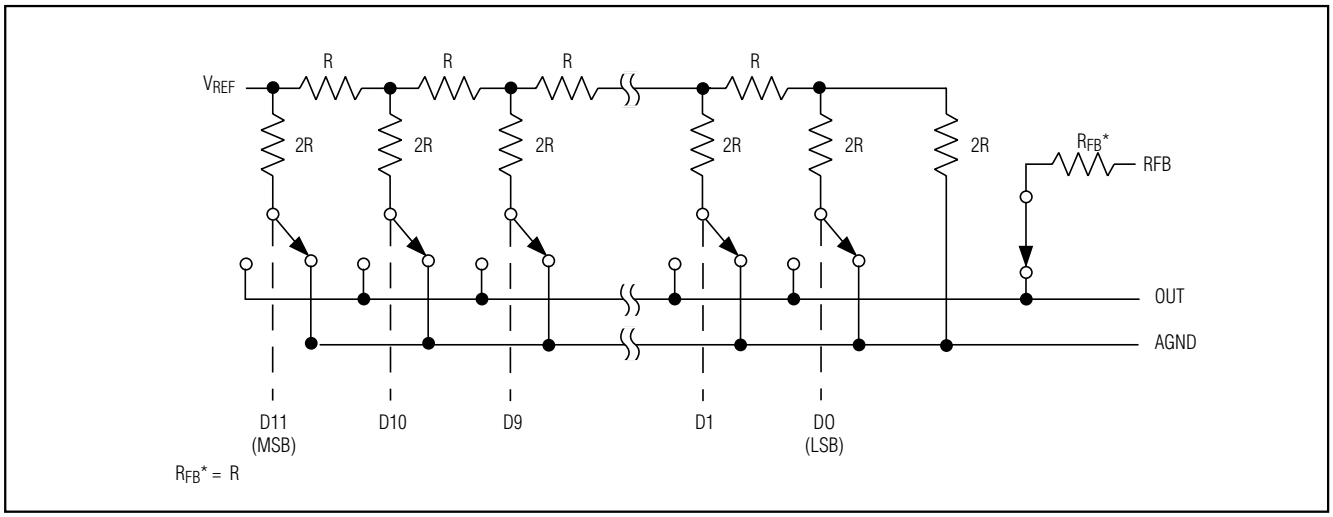


Figure 1. MAX551/MAX552 Simplified Circuit

+3V/+5V, 12-Bit, Serial, Multiplying DACs in 10-Pin µMAX Package

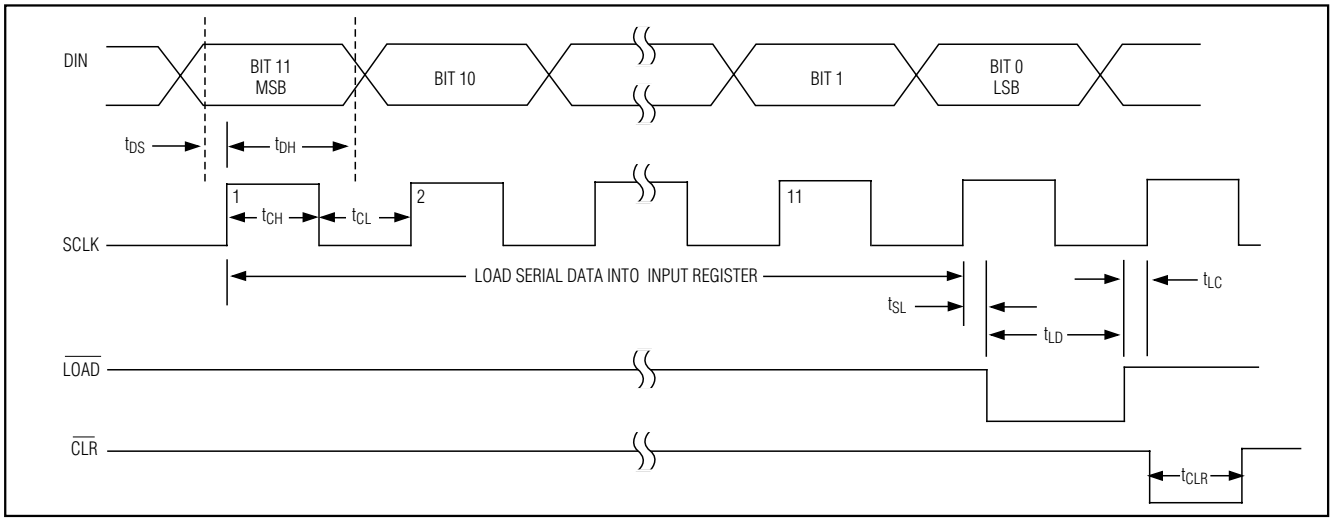


Figure 2. Write-Cycle Timing Diagram

Detailed Description

The MAX551/MAX552 digital-to-analog converter (DAC) circuits consist of a laser-trimmed, thin-film R-2R resistor array with NMOS current switches (Figure 1). Binary-weighted currents are switched to either OUT or AGND, depending on the status of each input data bit. Although the currents at OUT and AGND depend on the digital input code, the sum of the two output currents is always equal to the input current at REF.

The output current (I_{OUT}) can be converted into a voltage by adding an external output amplifier (Figure 3). The REF input accepts a wide range of signals, including fixed and time-varying voltage or current inputs. If a current source is used at the reference input, use a low-tempco, external feedback resistor in place of the internal feedback resistor (R_{FB}) to minimize gain variation with temperature.

The internal feedback resistor (R_{FB}) is compensated with an NMOS switch that matches the NMOS switches used in the R-2R array, resulting in excellent supply rejection and gain-temperature coefficient.

The OUT pin output capacitance (C_{OUT}) is code dependent. C_{OUT} is typically 14pF at 000hex and 20pF at FFFhex.

Table 1. Unipolar Binary-Code Table for Circuit of Figure 3

DIGITAL INPUT MSB		LSB	ANALOG OUTPUT
1111	1111	1111	$-V_{REF}\left(\frac{4095}{4096}\right)$
1000	0000	0000	$-V_{REF}\left(\frac{2048}{4096}\right) = -\frac{V_{REF}}{2}$
0000	0000	0001	$-V_{REF}\left(\frac{1}{4096}\right)$
0000	0000	0000	0

Serial Interface

The MAX551/MAX552 serial interface is compatible with the SPI/QSPI and MICROWIRE serial-interface standards. These devices accept serial clocks up to 12.5MHz (50% duty cycle). If the SCLK input is not

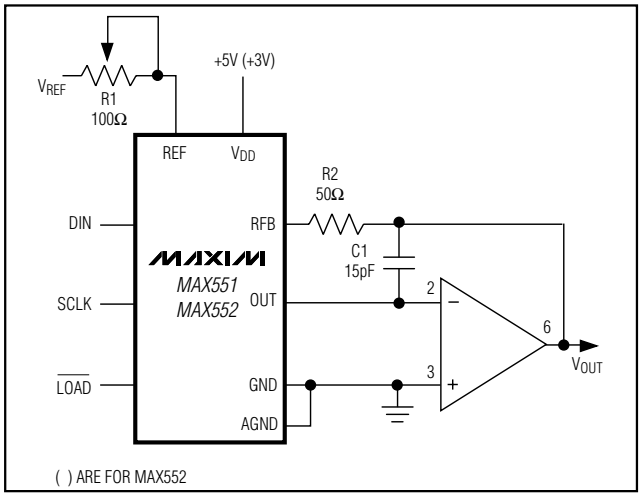


Figure 3. Unipolar Operation

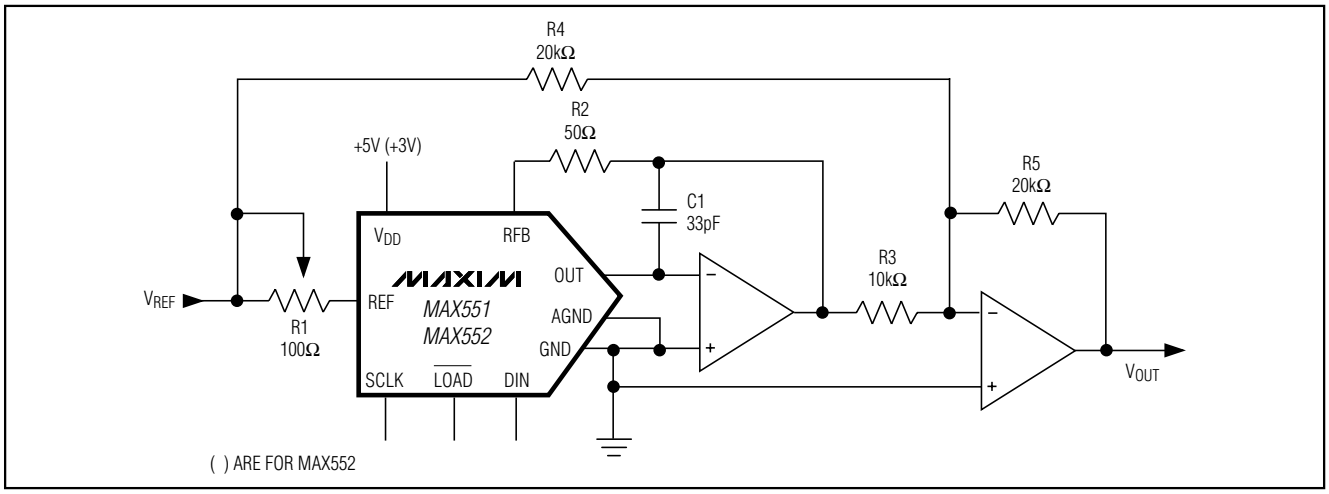


Figure 4. Bipolar Operation

Table 2. Offset Binary-Code Table for Circuit of Figure 4

DIGITAL INPUT MSB		LSB	ANALOG OUTPUT
1111	1111	1111	$+V_{REF}\left(\frac{2047}{2048}\right)$
1000	0000	0001	$+V_{REF}\left(\frac{1}{2048}\right)$
1000	0000	0000	0
0111	1111	1111	$-V_{REF}\left(\frac{1}{2048}\right)$
0000	0000	0000	$-V_{REF}\left(\frac{2048}{2048}\right)$

symmetrical, then the clock signal used must meet the t_{CH} and t_{CL} requirements given in the *Electrical Characteristics*.

Figure 2 shows the MAX551/MAX552 timing diagram. The most significant bit (MSB) is always loaded first on SCLK's rising edge. When all data is shifted into the input register, the DAC register is loaded by driving the $\overline{LOAD}$ signal low. The DAC register is transparent when $\overline{LOAD}$ is low and latched when $\overline{LOAD}$ is high. The MAX551/MAX552 digital inputs are compatible with CMOS logic levels. The MAX551's inputs are also compatible with TTL logic.

Unipolar Operation

Figure 3 shows the MAX551/MAX552's basic application. This circuit is used for unipolar operation or 2-quadrant multiplication. The code table for this mode is given in Table 1. Note that the output's polarity is the opposite of the reference voltage polarity.

In many applications the gain accuracy is sufficient and gain adjustment is not necessary. In these cases, resistors R1 and R2 in Figure 3 can be omitted. If the gain is trimmed and the DAC is operated over a wide temperature range, use low-tempco (<300ppm/°C) resistors for R1 and R2. Capacitor C1 provides phase compensation and reduces overshoot and ringing when fast amplifiers are used at the DAC's output.

Bipolar Operation

Figure 4 shows the MAX551/MAX552 operating in bipolar (or 4-quadrant multiplying) mode. Matched resistors R3, R4, and R5 must be of the same material (preferably metal film or wire-wound) for good temperature-tracking characteristics (<15ppm/°C) and should match to 0.01% for 12-bit performance. The output code is offset binary, as listed in Table 2.

To adjust the circuit, load the DAC with a code of 1000 0000 0000 and trim R1 for a 0V output. With R1 and R2 omitted, an alternative zero trim is needed to adjust the ratio of R3 and R4 for 0V out. Trim full scale by loading the DAC with all 0s or 1s and adjusting the V_{REF} amplitude or varying R5 until the desired positive or negative output is obtained. In applications where gain trim is not required, omit resistors R1 and R2. If gain trim is desired and the DAC is operated over a wide temperature range, then low-tempco (<300ppm/°C) resistors should be used.

+3V/+5V, 12-Bit, Serial, Multiplying DACs in 10-Pin µMAX Package

Applications Information

Output Amplifier

For best linearity, terminate OUT and GND at exactly 0V. In most applications, OUT is connected to an inverting op amp's summing junction. The amplifier's input offset voltage can degrade the DAC's linearity by causing OUT to be terminated to a nonzero voltage. The resulting error is:

$$\text{Error Voltage} = V_{OS} (1 + R_{FB} / R_O)$$

where V_{OS} = is the op amp's offset and R_O is the DAC's output resistance, which is code dependent. The maximum error voltage ($R_O = R_{FB}$) is $2V_{OS}$; the minimum error voltage ($R_O = \infty$) is V_{OS}. To minimize this error, use a low-offset amplifier such as the MAX4166 (unipolar output) or the MAX427 (bipolar output). Otherwise, the amplifier offset must be trimmed to zero. A good guide rule is that V_{OS} should be no more than 1/10LSB.

The output amplifier's input bias current (I_B) can also limit performance, since $I_B \times R_{FB}$ generates an offset error. Choose an op amp with an I_B much less than (e.g., one-tenth) the DAC's 1LSB output current (typically 111nA when V_{REF} = 5V, and 55.5nA when V_{REF} = 2.5V). Offset and linearity can also be impaired if the output amplifier's noninverting input is grounded through a bias-current compensation resistor. This resistor adds to the offset at this pin and thus should not be used. For best performance, connect the noninverting input directly to ground.

In static or DC applications, the output amplifier's characteristics are not critical. In higher speed applications in which either the reference input is an AC signal or the DAC output must quickly settle to a new programmed value, the output op amp's AC parameters must be considered.

A compensation capacitor, C1, may be required when the DAC is used with a high-speed output amplifier. The purpose of the capacitor is to cancel the pole formed by the DAC output capacitance, C_{OUT}, and the internal feedback resistor, R_{FB}. Its value depends on the type of op amp used but typically ranges from 14pF to 30pF. Too small a value causes output ringing, while excess capacitance overdamps the output. C1's size can be minimized and the output voltage settling time improved by keeping the circuit-board trace short and stray capacitance at OUT as low as possible.

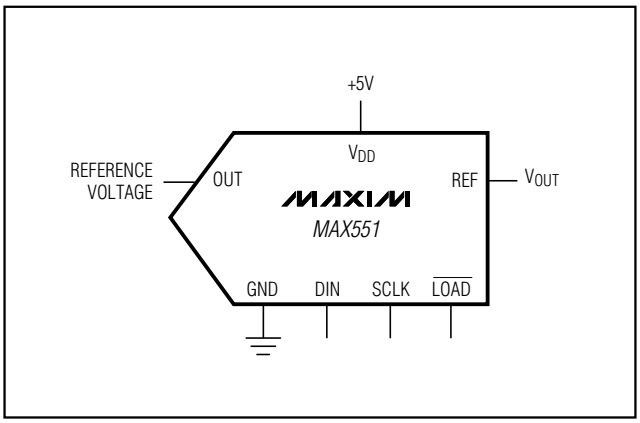


Figure 5. Single-Supply, Voltage Mode Operation

Single-Supply Operation

Reference Voltage

The MAX551/MAX552 are true 4-quadrant DACs, making them ideal for multiplying applications. The reference input accepts both AC and DC signals within a voltage range of ±6V. The R-2R ladder is implemented with thin-film resistors, enabling the use of unipolar or bipolar reference voltages with only a single power supply for the DAC. The voltage at the V_{REF} input sets the DAC's full-scale output voltage.

If the reference is too noisy, it should be bypassed to GND (AGND on the 10-pin µMAX package) with a 0.1µF ceramic capacitor located as close to the REF pin as possible.

Voltage Mode (MAX551)

The MAX551 can be conveniently used in voltage mode, single-supply operation with OUT biased at any voltage between GND and V_{DD}. OUT must not be allowed to go 0.3V lower than GND or 0.3V higher than V_{DD}. Otherwise, internal diodes turn on, causing a high current flow that could damage the device.

Figure 5 shows the MAX551 connected as a voltage output DAC. In this mode of operation, the OUT pin is connected to the reference-voltage source, and the GND pin is connected to the PCB ground plane. The DAC output now appears at the REF pin, which has a constant resistance equal to the reference input resistance (11kΩ typ). This output should be buffered with an op amp when a lower output impedance is required. The RFB pin is not used in this mode. The reference input (OUT) impedance is code dependent, and the circuit's response time depends on the reference source's behavior with changing load conditions.

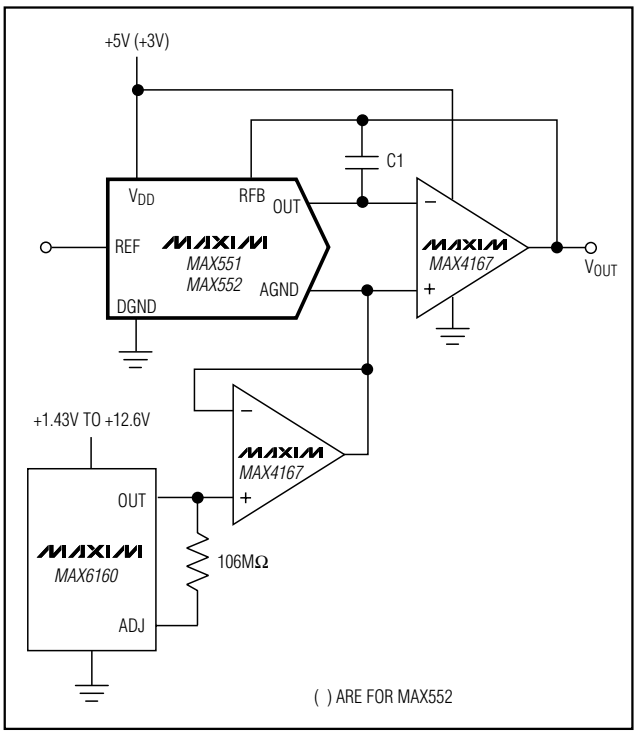


Figure 6. Single-Supply, Current Mode Operation

An advantage of voltage mode operation is that a negative reference is not required for a positive output. Note that the reference input (OUT) must always be positive and is limited to no more than 2V when V_{DD} is 5V. The unipolar and bipolar circuits in Figures 3 and 4 can be converted to voltage mode.

Current Mode

Figure 6 shows the MAX551/MAX552 in a current output configuration in which the output amplifier is powered from a single supply, and AGND is biased to 1.23V. With 0V applied to the REF input, the output can be programmed from 1.23V (zero code) to 2.46V (full scale). With 2.45V applied to REF, the output can be programmed from 1.23V (zero code) to 0.01V (full scale).

The MAX4166 op amp that drives AGND maintains the 1.23V bias as AGND's impedance changes with the DAC's digital code, from high impedance (zero code) to 7kΩ minimum (full scale).

Using an AC Reference

In applications where reference voltage has AC signal components, the MAX551/MAX552 have multiplying capability within the reference input range of ±6V. If the DAC and the output amplifier are operated with a single supply voltage, then an AC reference input can be offset with the circuit shown in Figure 7 to prevent the DAC output voltage from exceeding the output amplifier's negative output rail. The reference input's typical -3dB bandwidth is greater than 700kHz, as shown in the *Typical Operating Characteristics* graphs.

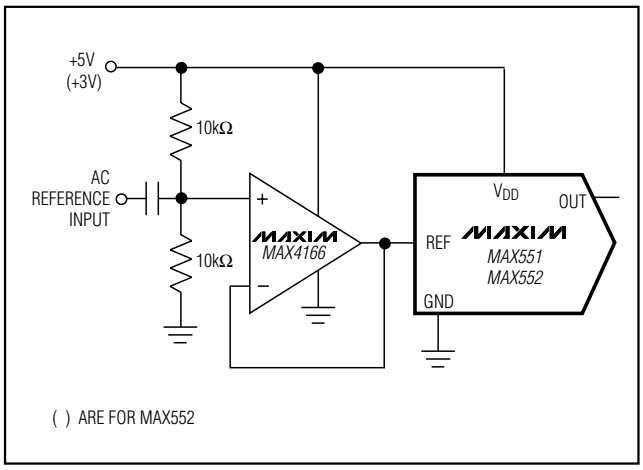


Figure 7. Single-Supply AC Reference Input Circuit

Offsetting AGND

The MAX551/MAX552 provide separate AGND and GND inputs in the µMAX package. With this package, AGND can be biased above GND to provide an arbitrary nonzero output voltage for a "0" input code (Figure 8).

Layout, Grounding, and Bypassing

Bypass V_{DD} with a 0.1µF capacitor, located as close to V_{DD} and GND as possible. The ground pins (AGND and GND) should be connected in a star configuration to the highest quality ground available, which should be located as close to the MAX551/MAX552 as possible.

Since OUT and the output amplifier's noninverting input are sensitive to offset voltage, nodes that are to be grounded should be connected directly to a single-point ground through a separate, low-resistance (less than 0.2Ω) connection. The current at OUT and AGND varies with input code, creating a code-dependent error if these terminals are connected to ground (or virtual ground) through a resistive path.

Parasitic coupling of the signal from REF to OUT is an error source in dynamic applications. This coupling is normally a function of board layout and pin-to-pin package capacitance. Minimize digital feedthrough with guard traces between digital inputs, REF, and OUT pins.

+3V/+5V, 12-Bit, Serial, Multiplying DACs in 10-Pin µMAX Package

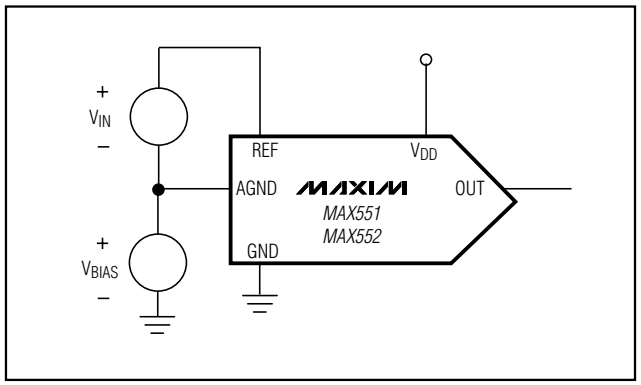


Figure 8. AGND Bias Current

The MAX551/MAX552 have high-impedance digital inputs. To minimize noise pickup, tie them to either V_{DD} or GND when they are not in use. As a good practice, connect active inputs to V_{DD} or GND through high-value resistors (1MΩ) to prevent static charge accumulation if the pins are left floating, such as when a circuit card is left unconnected.

The $\overline{CLR}$ input on the µMAX device has an internal pull-up resistor with a typical value of 125kΩ. If the $\overline{CLR}$ input is not used, tie it to V_{DD} to minimize supply current.

_Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE	LINEARITY (LSB)
MAX552ACPA	0°C to +70°C	8 Plastic DIP	±1/2
MAX552BCPA	0°C to +70°C	8 Plastic DIP	±1
MAX552ACUB	0°C to +70°C	10 µMAX	±1/2
MAX552BCUB	0°C to +70°C	10 µMAX	±1
MAX552AEPA	-40°C to +85°C	8 Plastic DIP	±1/2
MAX552BEPA	-40°C to +85°C	8 Plastic DIP	±1
MAX552AEUB	-40°C to +85°C	10 µMAX	±1/2
MAX552BEUB	-40°C to +85°C	10 µMAX	±1

Chip Information

TRANSISTOR COUNT: 887

SUBSTRATE CONNECTED TO V_{DD}

Package Information

For the latest package outline information, go to **www.maxim-ic.com/packages**.

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